

EC3SMC-15.000M TR

[Click part number to visit Part Number Details page](#)

REGULATORY COMPLIANCE (Data Sheet downloaded on Apr 18, 2017)



ITEM DESCRIPTION

Quartz Crystal Resonator HC49/UP 4 Pad Surface Mount (SMD) 4.0mm Height Metal Resistance Weld Seal 15.000MHz ± 30 ppm at 25°C, ± 50 ppm over 0°C to +70°C 18pF Parallel Resonant

ELECTRICAL SPECIFICATIONS

Nominal Frequency	15.000MHz
Frequency Tolerance/Stability	± 30 ppm at 25°C, ± 50 ppm over 0°C to +70°C
Aging at 25°C	± 5 ppm/year Maximum
Load Capacitance	18pF Parallel Resonant
Shunt Capacitance (C0)	7pF Maximum
Equivalent Series Resistance	60 Ohms Maximum
Mode of Operation	AT-Cut Fundamental
Drive Level	1mWatts Maximum
Storage Temperature Range	-40°C to +85°C
Insulation Resistance	500 Megaohms Minimum at 100Vdc

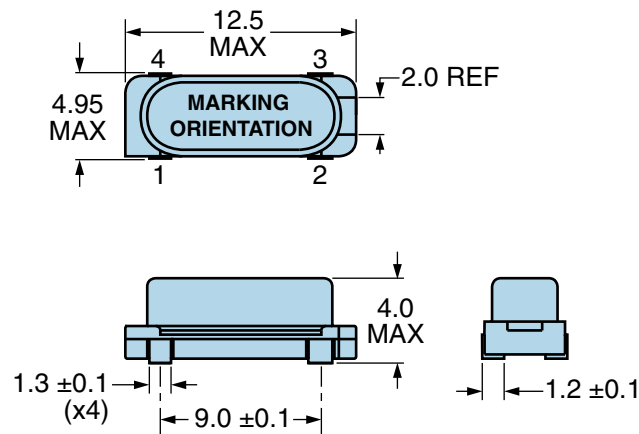
ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

Fine Leak Test	MIL-STD-883, Method 1014 Condition A
Gross Leak Test	MIL-STD-883, Method 1014 Condition C
Mechanical Shock	MIL-STD-202, Method 213 Condition C
Resistance to Soldering Heat	MIL-STD-202, Method 210
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010
Vibration	MIL-STD-883, Method 2007 Condition A

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MECHANICAL DIMENSIONS (all dimensions in millimeters)

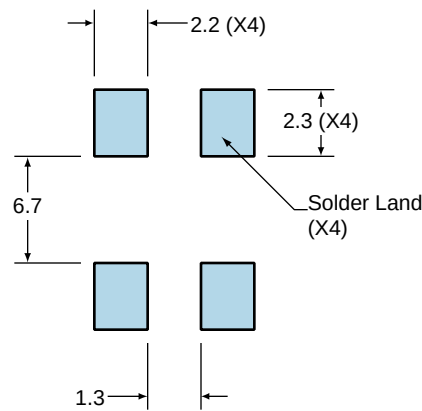


PIN	CONNECTION
1	Crystal
2	Connected to Pin 3
3	Connected to Pin 2
4	Crystal

LINE	MARKING
1	E15.000 <i>E=EclipseTek Designator</i>

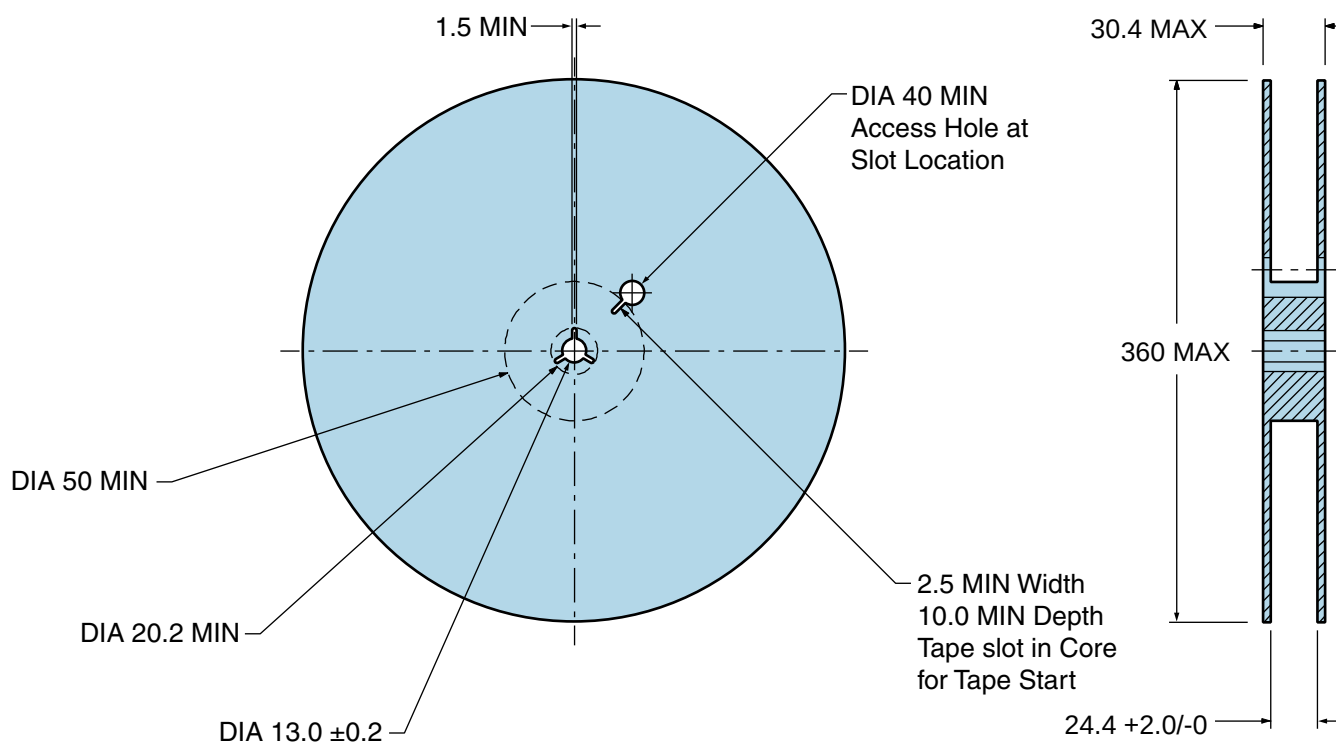
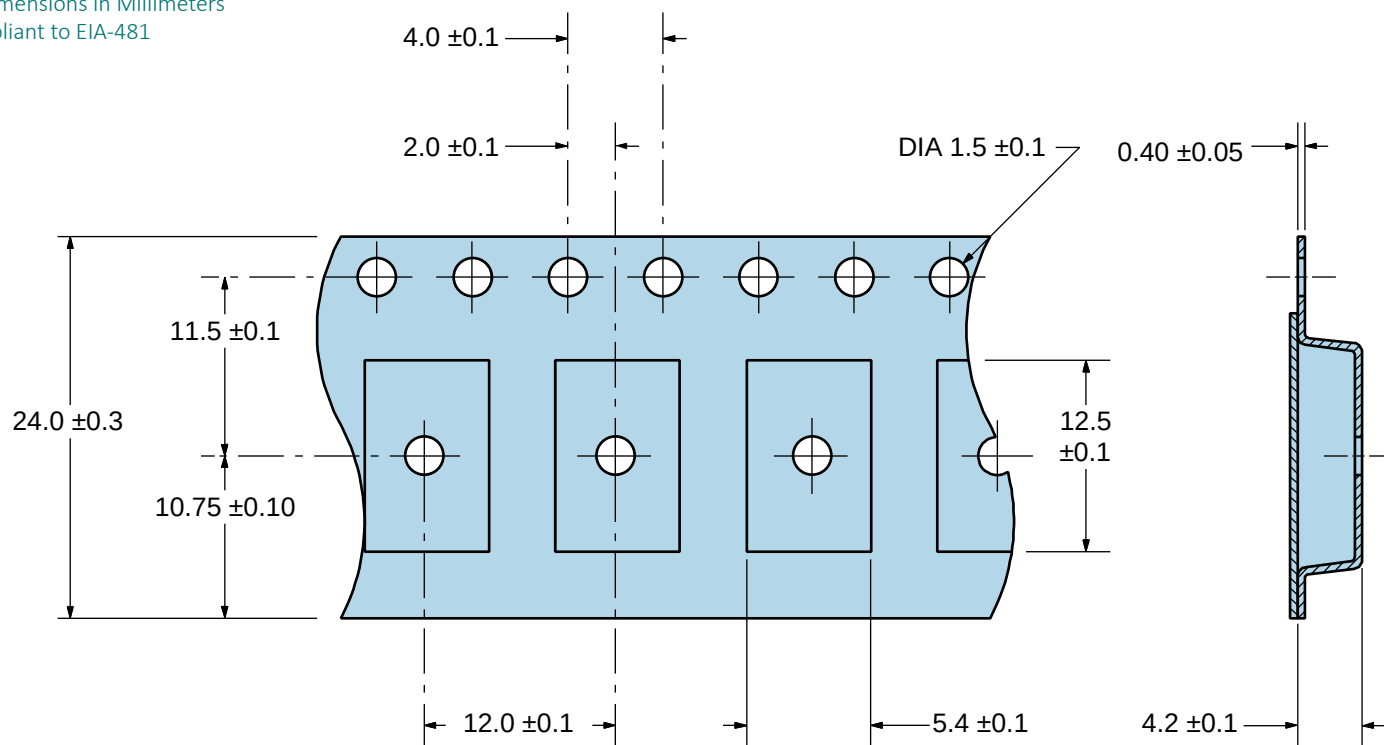
Suggested Solder Pad Layout

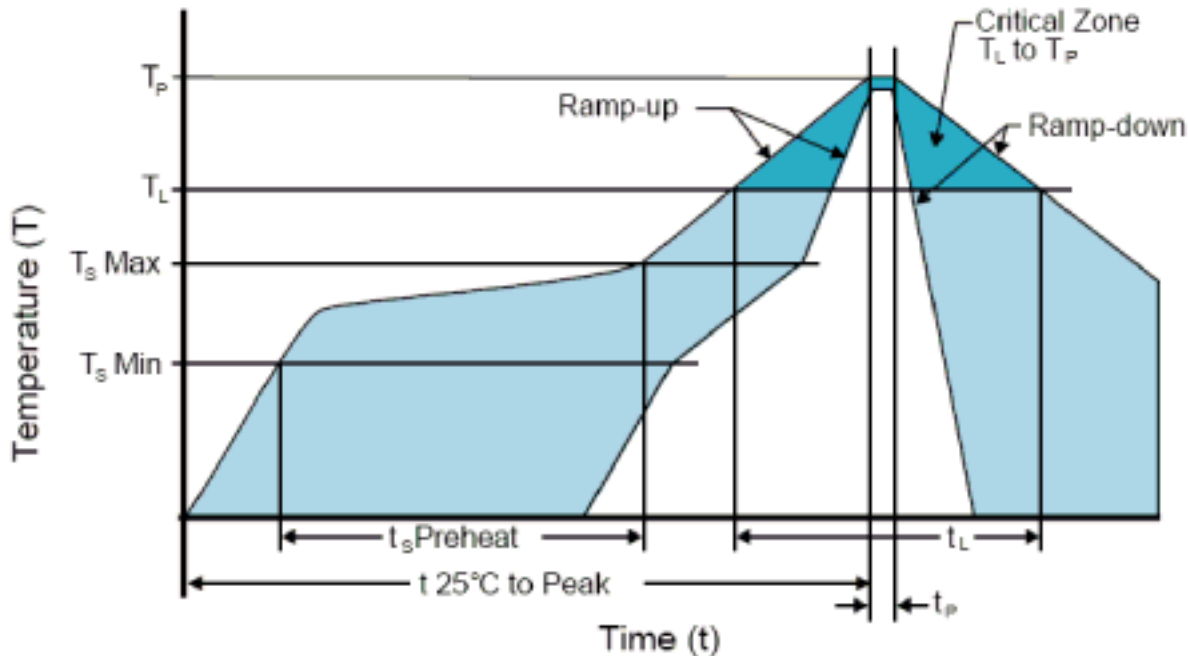
All Dimensions in Millimeters



All Tolerances are ±0.1

All Dimensions in Millimeters
Compliant to EIA-481



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Recommended Solder Reflow Methods**Low Temperature Infrared/Convection 225°C**

TS MAX to TL (Ramp-up Rate)	5°C/Second Maximum
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Preheat

- Temperature Minimum (TS MIN)	N/A
- Temperature Typical (TS TYP)	150°C
- Temperature Maximum (TS MAX)	N/A
- Time (ts MIN)	30 - 60 Seconds

Ramp-up Rate (TL to TP)	5°C/Second Maximum
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Time Maintained Above:

- Temperature (TL)	150°C
- Time (tL)	200 Seconds Maximum

Peak Temperature (TP)	225°C Maximum
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Target Peak Temperature (TP Target)	225°C Maximum 2 Times
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Time within 5°C of actual peak (tP)	80 Seconds Maximum 2 Times
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Ramp-down Rate	5°C/Second Maximum
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Time 25°C to Peak Temperature (t)	N/A
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Moisture Sensitivity Level	Level 1
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Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.